



IXYS Corporation USA

October 3, 2013

Certificate of Compliance RoHS 2

Herewith we confirm that

IXYS Devices and Chip Products

are in compliance with the requirements detailed in the

DIRECTIVE 2011/65/EU of the EUROPEAN PARLIAMENT and of the COUNCIL

Effective January 3, 2013

Exception: IXYS devices currently uses a high temperature leaded solder for chip attach allowable under RoHS exemption 7A until April 2015.

7(a)	Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead)
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A handwritten signature in black ink that reads "Gordon Rosete".

Gordon Rosete
IXYS Corporation
Head of Quality Dept.
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Milpitas, CA USA 95035

